TELEFUNKEN Semiconductors

Very High Intensity DH-red LED, ø 3 mm Tinted Diffused

Color	Туре	Technology	Angle of half intensity
			±φ
Double hetero red	TLDR4400	GaAlAs on GaAs	40°

Description

This LED contains the double heterojunction (DH) GaAlAs on GaAs technology.

This deep red LED can be utilized over a wide range of drive current. It can be DC or pulse driven to achieve desired light output.

The device is available in a 3 mm tinted diffused package.

Features

- Exceptional brightness
- Very high intensity even at low drive currents
- Wide viewing angle
- Low forward voltage
- 3 mm (T-1) tinted diffused package
- Deep red color
- Categorized for luminous intensity
- Outstanding material efficiency

Applications

Bright ambient lighting conditions
Battery powered equipment
Indoor and outdoor information displays
Portable equipment
Telecommunication indicators
General use

Rev. A1: 01.06.1995

Absolute Maximum Ratings

 $T_{amb} = 25$ °C, unless otherwise specified

Double hetero red (TLDR4400)

Parameter	Test Conditions	Туре	Symbol	Value	Unit
Reverse voltage	$I_R = 10 \mu A$		V_{R}	6	V
DC forward current			I_{F}	50	mA
Surge forward current	$t_p \le 10 \ \mu s$		I_{FSM}	1	A
Power dissipation	$T_{amb} \le 30^{\circ} C$		P_{V}	100	mW
Junction temperature			T _i	100	°C
Storage temperature range			$T_{ m stg}$	-55 to +100	°C
Soldering temperature	$t \le 5 s$,		T_{sd}	260	°C
	2 mm from body				
Thermal resistance junction/ambient			R_{thJA}	700	K/W

Optical and Electrical Characteristics

 $T_{amb} = 25$ °C, unless otherwise specified

Double hetero red (TLDR4400)

Parameter	Test Conditions	Type	Symbol	Min	Тур	Max	Unit
Luminous intensity	$I_F = 20 \text{ mA}$		I_V	25	45		mcd
	$I_F = 1 \text{ mA}$		I_V		2		mcd
Dominant wavelength	$I_F = 20 \text{ mA}$		$\lambda_{ m d}$		648		nm
Peak wavelength	$I_F = 20 \text{ mA}$		λ_{p}		650		nm
Angle of half intensity	$I_F = 20 \text{ mA}$		φ		±40		deg
Spectral line half width	$I_F = 20 \text{ mA}$		Δλ		20		nm
Forward voltage	$I_F = 20 \text{ mA}$		V_{F}		1.8	2.2	V
Reverse current	$V_R = 6 V$		I_R			10	μΑ
Junction capacitance	$V_R = 0$, $f = 1$ MHz		Cj		30		pF

2 (6) Rev. A1: 01.06.1995

TEMIC

Typical Characteristics ($T_{amb} = 25$ °C, unless otherwise specified)

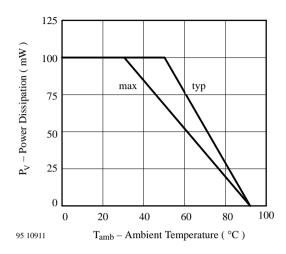


Figure 1. Power Dissipation vs. Ambient Temperature

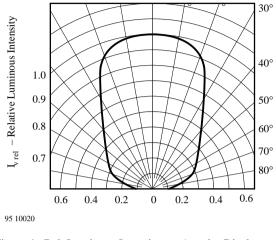


Figure 4. Rel. Luminous Intensity vs. Angular Displacement

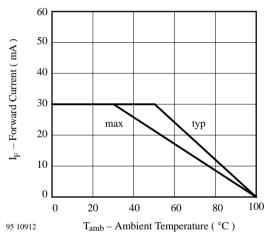


Figure 2. Forward Current vs. Ambient Temperature

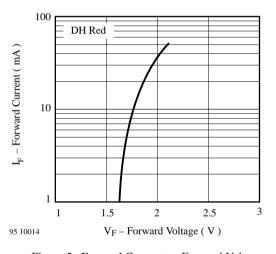


Figure 5. Forward Current vs. Forward Voltage

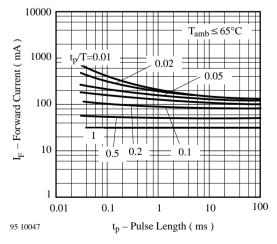


Figure 3. Forward Current vs. Pulse Length

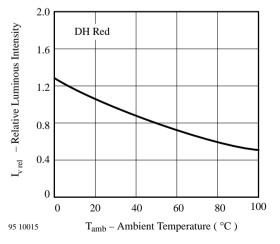


Figure 6. Rel. Luminous Intensity vs. Ambient Temperature

Rev. A1: 01.06.1995

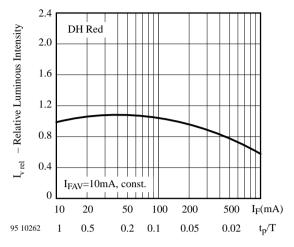


Figure 7. Rel. Lumin. Intensity vs. Forw. Current/Duty Cycle

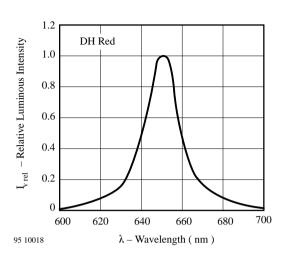


Figure 9. Relative Luminous Intensity vs. Wavelength

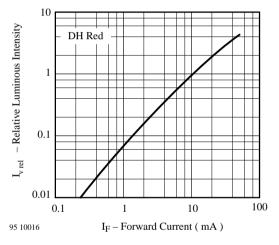
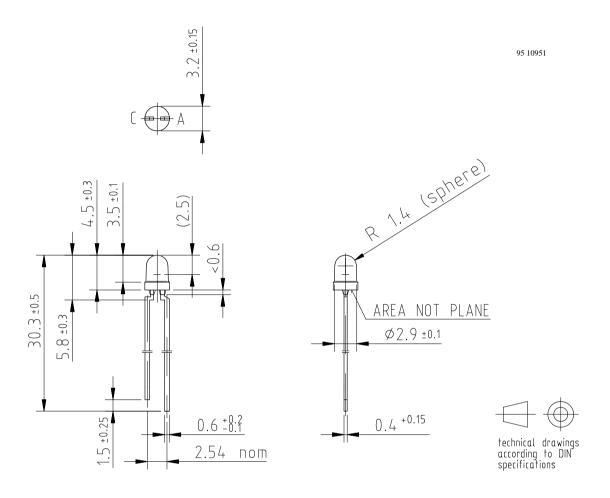


Figure 8. Relative Luminous Intensity vs. Forward Current

4 (6) Rev. A1: 01.06.1995

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Dimensions in mm



Rev. A1: 01.06.1995



TLDR4400

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Ozone Depleting Substances Policy Statement

It is the policy of TEMIC TELEFUNKEN microelectronic GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice. Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use TEMIC products for any unintended or unauthorized application, the buyer shall indemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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6 (6) Rev. A1: 01.06.1995